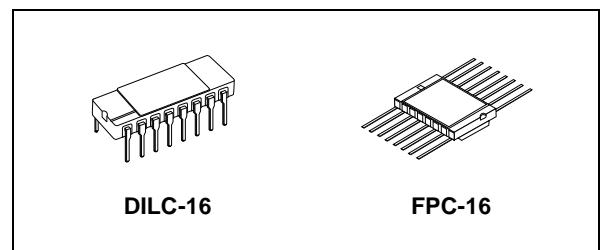


## RAD-HARD HEX BUS BUFFER WITH 3 STATE OUTPUT NON INVERTING

- HIGH SPEED:  
 $t_{PD} = 9\text{ns}$  (TYP.) at  $V_{CC} = 6\text{V}$
- LOW POWER DISSIPATION:  
 $I_{CC} = 4\mu\text{A}$ (MAX.) at  $T_A=25^\circ\text{C}$
- HIGH NOISE IMMUNITY:  
 $V_{NIH} = V_{NIL} = 28\%$   $V_{CC}$  (MIN.)
- SYMMETRICAL OUTPUT IMPEDANCE:  
 $|I_{OHL}| = I_{OL} = 6\text{mA}$  (MIN)
- BALANCED PROPAGATION DELAYS:  
 $t_{PLH} \approx t_{PHL}$
- WIDE OPERATING VOLTAGE RANGE:  
 $V_{CC}$  (OPR) = 2V to 6V
- PIN AND FUNCTION COMPATIBLE WITH 54 SERIES 367
- SPACE GRADE-1: ESA SCC QUALIFIED
- 50 krad QUALIFIED, 100 krad AVAILABLE ON REQUEST
- NO SEL UNDER HIGH LET HEAVY IONS IRRADIATION
- DEVICE FULLY COMPLIANT WITH SCC-9401-044

### DESCRIPTION

The M54HC367 is an high speed CMOS HEX BUS BUFFER 3-STATE OUTPUTS fabricated with silicon gate C<sup>2</sup>MOS technology.



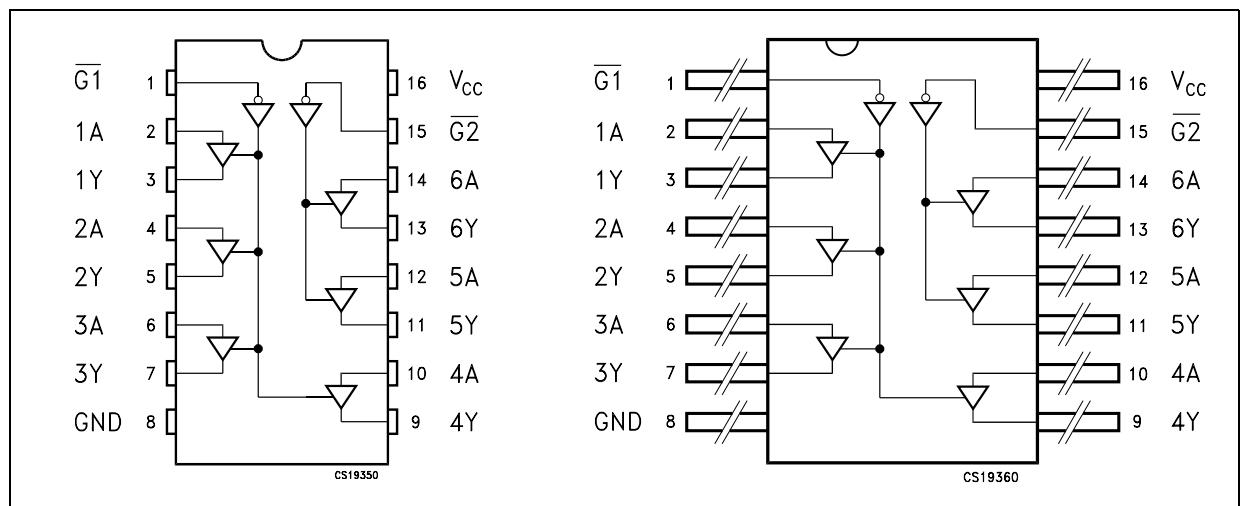
### ORDER CODES

PACKAGE	FM	EM
DILC	M54HC367D	M54HC367D1
FPC	M54HC367K	M54HC367K1

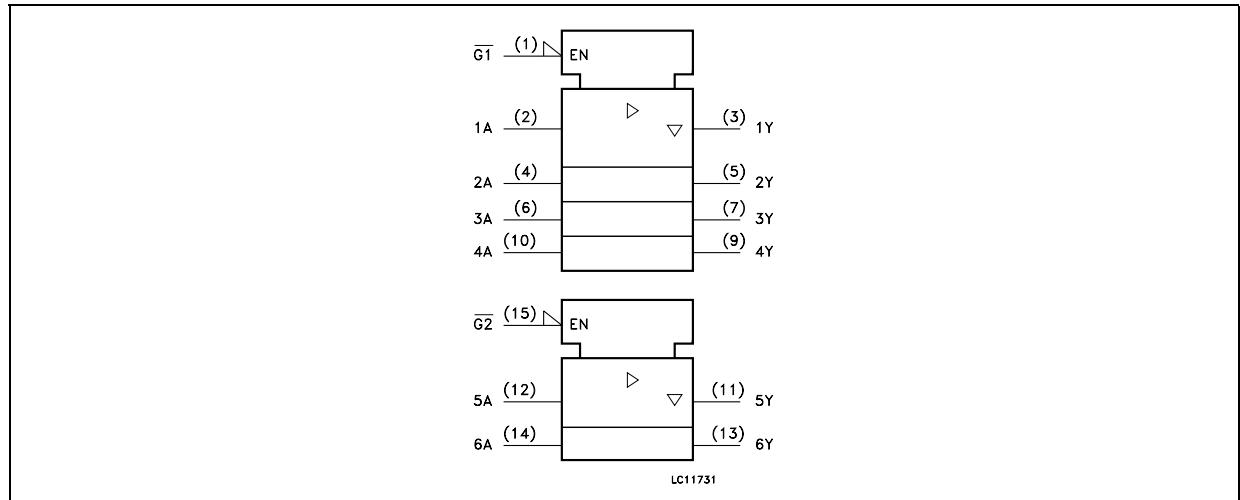
This device contains six buffers, four buffers are controlled by an enable input ( $G_1$ ) and the other two buffers are controlled by the other enable input ( $\bar{G}_2$ ); the outputs of each buffer group are enabled when  $G_1$  and/or  $\bar{G}_2$  inputs are held low, and when held high, these outputs are disabled in a high-impedance state.

All inputs are equipped with protection circuits against static discharge and transient excess voltage.

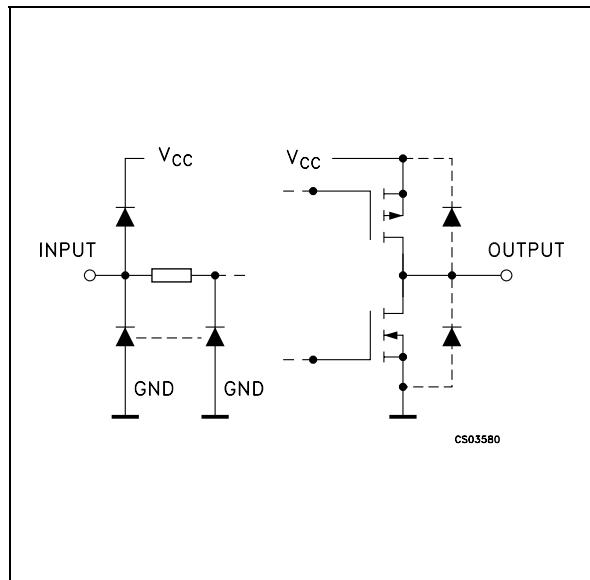
### PIN CONNECTION



**Figure 1: IEC Logic Symbols**



**Figure 2: Input And Output Equivalent Circuit**



**Table 1: Pin Description**

PIN N°	SYMBOL	NAME AND FUNCTION
1, 15	G1, G2	3 State Output Enable Input
2, 4, 6, 10, 12, 14	1A to 6A	Data Inputs
3, 5, 7, 9, 11, 13	1Y to 6Y	Data Outputs
8	GND	Ground (0V)
16	V <sub>CC</sub>	Positive Supply Voltage

**Table 2: Truth Table**

INPUTS		OUTPUTS
$\bar{G}$	$A_n$	$Y_n$
L	L	L
L	H	H
H	X	Z

X: Don't Care

Z: High Impedance

**Table 3: Absolute Maximum Ratings**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply Voltage	-0.5 to +7	V
$V_I$	DC Input Voltage	-0.5 to $V_{CC} + 0.5$	V
$V_O$	DC Output Voltage	-0.5 to $V_{CC} + 0.5$	V
$I_{IK}$	DC Input Diode Current	$\pm 20$	mA
$I_{OK}$	DC Output Diode Current	$\pm 20$	mA
$I_O$	DC Output Current	$\pm 35$	mA
$I_{CC}$ or $I_{GND}$	DC $V_{CC}$ or Ground Current	$\pm 70$	mA
$P_D$	Power Dissipation	420	mW
$T_{stg}$	Storage Temperature	-65 to +150	°C
$T_L$	Lead Temperature (10 sec)	265	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

**Table 4: Recommended Operating Conditions**

Symbol	Parameter	Value	Unit	
$V_{CC}$	Supply Voltage	2 to 6	V	
$V_I$	Input Voltage	0 to $V_{CC}$	V	
$V_O$	Output Voltage	0 to $V_{CC}$	V	
$T_{op}$	Operating Temperature	-55 to 125	°C	
$t_r, t_f$	Input Rise and Fall Time	$V_{CC} = 2.0V$	0 to 1000	ns
		$V_{CC} = 4.5V$	0 to 500	ns
		$V_{CC} = 6.0V$	0 to 400	ns

Table 5: DC Specifications

Symbol	Parameter	Test Condition		Value						Unit	
		$V_{CC}$ (V)		$T_A = 25^\circ C$			$-40 \text{ to } 85^\circ C$		$-55 \text{ to } 125^\circ C$		
				Min.	Typ.	Max.	Min.	Max.	Min.	Max.	
$V_{IH}$	High Level Input Voltage	2.0		1.5			1.5		1.5		V
		4.5		3.15			3.15		3.15		
		6.0		4.2			4.2		4.2		
$V_{IL}$	Low Level Input Voltage	2.0				0.5		0.5		0.5	V
		4.5				1.35		1.35		1.35	
		6.0				1.8		1.8		1.8	
$V_{OH}$	High Level Output Voltage	2.0	$I_O=-20 \mu A$	1.9	2.0		1.9		1.9		V
		4.5	$I_O=-20 \mu A$	4.4	4.5		4.4		4.4		
		6.0	$I_O=-20 \mu A$	5.9	6.0		5.9		5.9		
		4.5	$I_O=-6.0 mA$	4.18	4.31		4.13		4.10		
		6.0	$I_O=-7.8 mA$	5.68	5.8		5.63		5.60		
$V_{OL}$	Low Level Output Voltage	2.0	$I_O=20 \mu A$		0.0	0.1		0.1		0.1	V
		4.5	$I_O=20 \mu A$		0.0	0.1		0.1		0.1	
		6.0	$I_O=20 \mu A$		0.0	0.1		0.1		0.1	
		4.5	$I_O=6.0 mA$		0.17	0.26		0.33		0.40	
		6.0	$I_O=7.8 mA$		0.18	0.26		0.33		0.40	
$I_I$	Input Leakage Current	6.0	$V_I = V_{CC} \text{ or GND}$			$\pm 0.1$		$\pm 1$		$\pm 1$	$\mu A$
$I_{OZ}$	High Impedance Output Leakage Current	6.0	$V_I = V_{IH} \text{ or } V_{IL}$ $V_O = V_{CC} \text{ or GND}$			$\pm 0.5$		$\pm 5$		$\pm 10$	$\mu A$
$I_{CC}$	Quiescent Supply Current	6.0	$V_I = V_{CC} \text{ or GND}$			4		40		80	$\mu A$

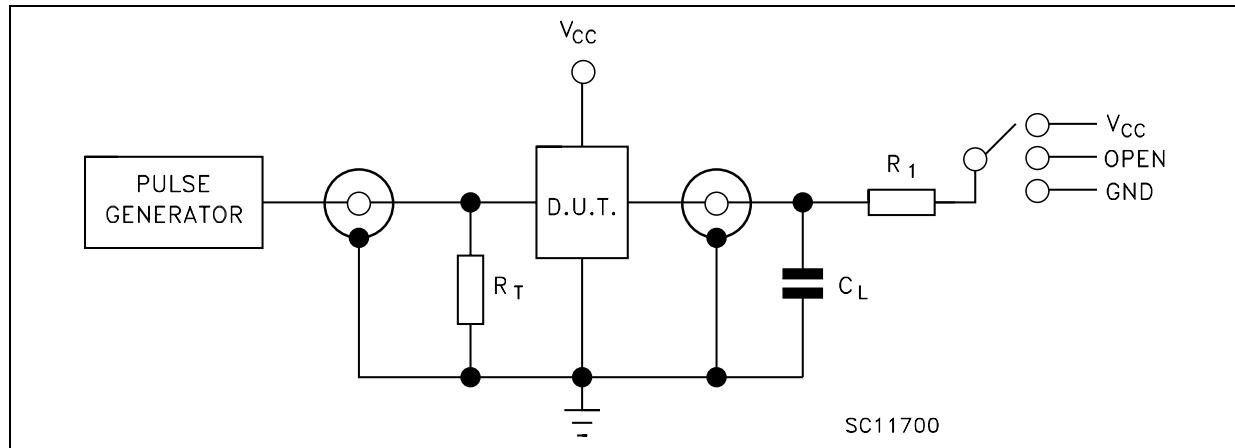
**Table 6: AC Electrical Characteristics ( $C_L = 50 \text{ pF}$ , Input  $t_r = t_f = 6\text{ns}$ )**

Symbol	Parameter	Test Condition			Value								Unit
		$V_{CC}$ (V)	$C_L$ (pF)		$T_A = 25^\circ\text{C}$			$-40 \text{ to } 85^\circ\text{C}$		$-55 \text{ to } 125^\circ\text{C}$			
					Min.	Typ.	Max.	Min.	Max.	Min.	Max.		
$t_{TLH} t_{THL}$	Output Transition Time	2.0	50			25	60		75		90		ns
		4.5				7	12		15		18		
		6.0				6	10		13		15		
$t_{PLH} t_{PHL}$	Propagation Delay Time	2.0	50			30	85		105		130		ns
		4.5				10	17		21		26		
		6.0				9	14		18		22		
		2.0	150			42	105		130		160		ns
		4.5				14	21		26		32		
		6.0				12	18		22		27		
$t_{PZL} t_{PZH}$	High Impedance Output Enable Time	2.0	50	$R_L = 1 \text{ k}\Omega$		36	90		115		135		ns
		4.5				11	18		23		27		
		6.0				9	15		20		23		
		2.0	150	$R_L = 1 \text{ k}\Omega$		49	110		140		165		ns
		4.5				15	22		28		33		
		6.0				13	19		24		28		
$t_{PLZ} t_{PHZ}$	High Impedance Output Disable Time	2.0	50	$R_L = 1 \text{ k}\Omega$		32	95		120		145		ns
		4.5				14	19		24		29		
		6.0				12	16		20		25		

**Table 7: Capacitive Characteristics**

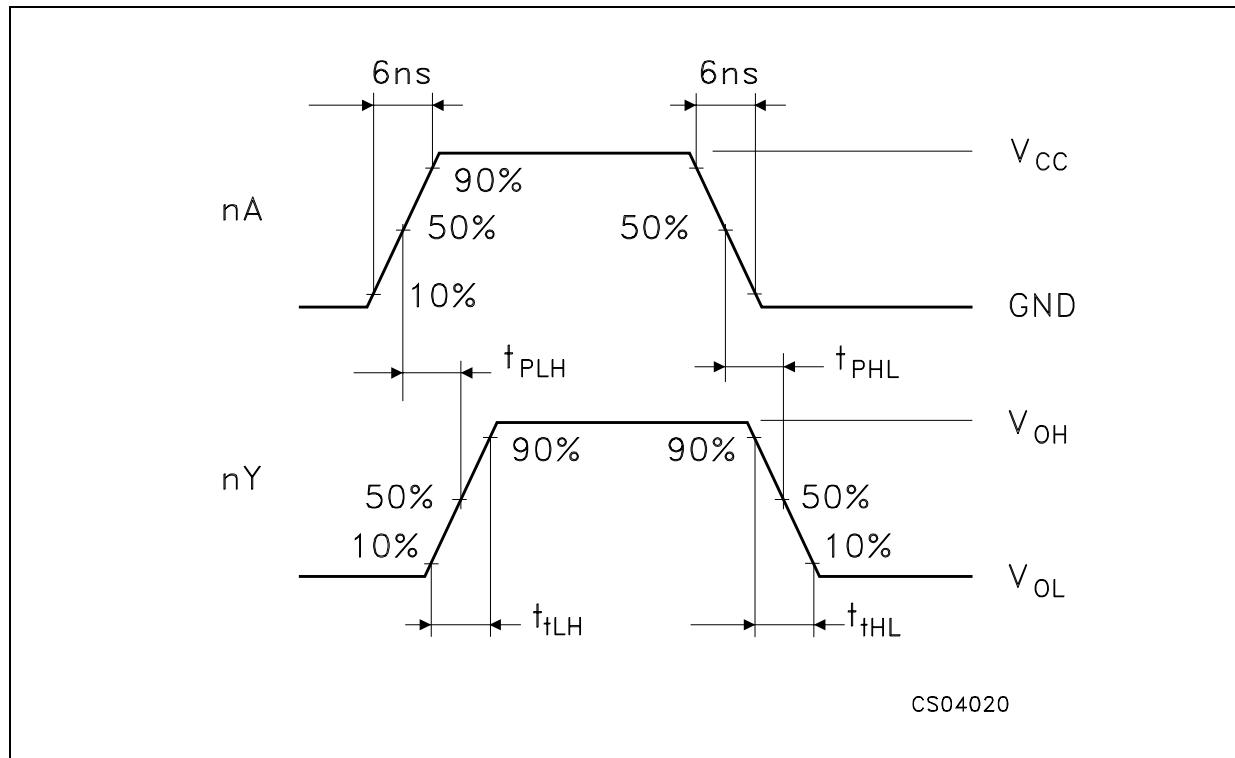
Symbol	Parameter	Test Condition			Value								Unit
		$V_{CC}$ (V)			$T_A = 25^\circ\text{C}$			$-40 \text{ to } 85^\circ\text{C}$		$-55 \text{ to } 125^\circ\text{C}$			
					Min.	Typ.	Max.	Min.	Max.	Min.	Max.		
$C_{IN}$	Input Capacitance					5	10		10		10	pF	
$C_{PD}$	Power Dissipation Capacitance (note 1)					33						pF	

1)  $C_{PD}$  is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit). Average operating current can be obtained by the following equation.  $I_{CC(\text{opr})} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/6$  (per Channel)

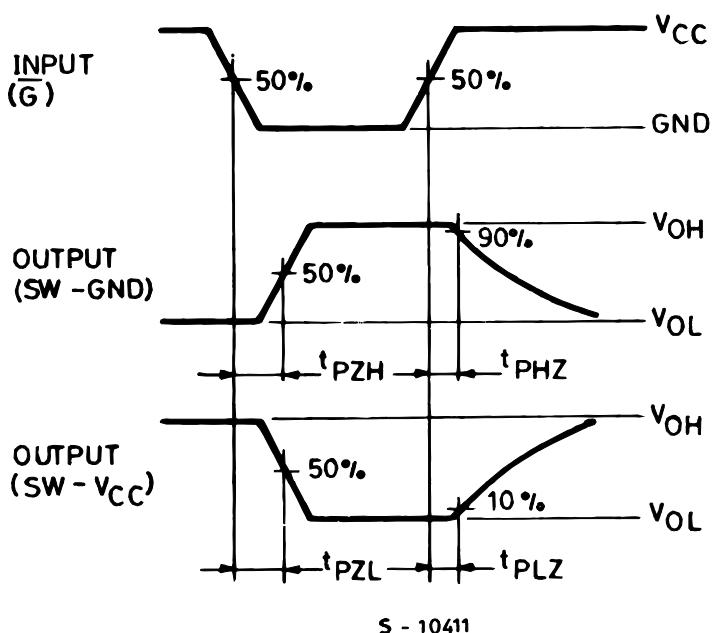
**Figure 3: Test Circuit**

SC11700

TEST	SWITCH
$t_{PLH}, t_{PHL}$	Open
$t_{PZL}, t_{PLZ}$	$V_{CC}$
$t_{PZH}, t_{PHZ}$	GND

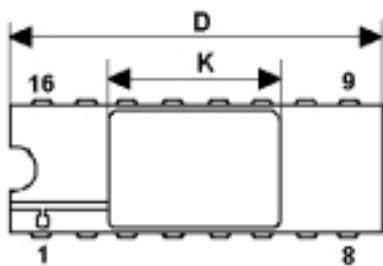
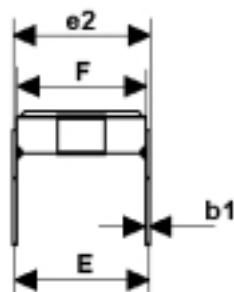
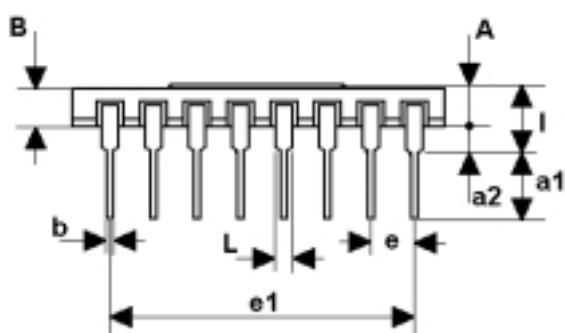
 $C_L = 50\text{pF}/150\text{pF}$  or equivalent (includes jig and probe capacitance) $R_1 = 1\text{K}\Omega$  or equivalent $R_T = Z_{OUT}$  of pulse generator (typically  $50\Omega$ )**Figure 4: Waveform - Propagation Delay Times (f=1MHz; 50% duty cycle)**

CS04020

Figure 5: Waveform - Output Enable And Disable Times ( $f=1\text{MHz}$ ; 50% duty cycle)

## DILC-16 MECHANICAL DATA

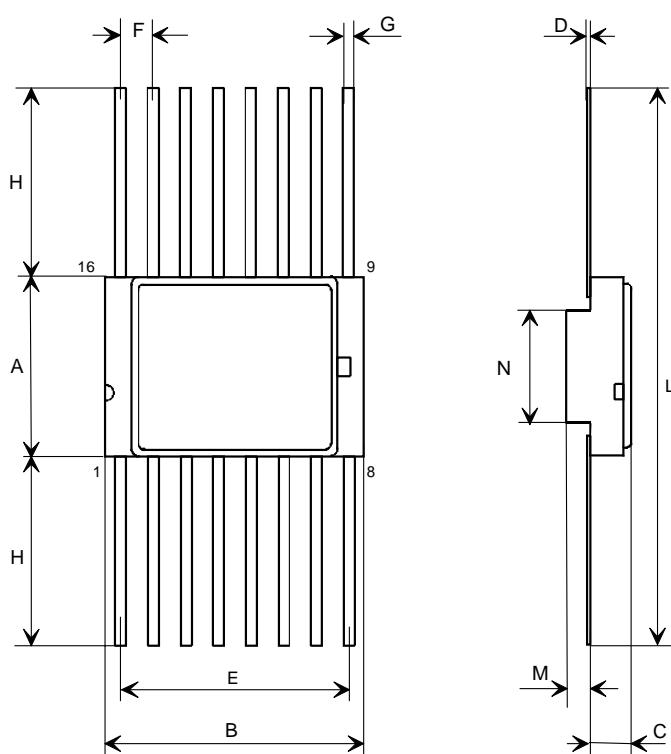
DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A	2.1		2.71	0.083		0.107
a1	3.00		3.70	0.118		0.146
a2	0.63	0.88	1.14	0.025	0.035	0.045
B	1.82		2.39	0.072		0.094
b	0.40	0.45	0.50	0.016	0.018	0.020
b1	0.20	0.254	0.30	0.008	0.010	0.012
D	20.06	20.32	20.58	0.790	0.800	0.810
e	7.36	7.62	7.87	0.290	0.300	0.310
e1		2.54			0.100	
e2	17.65	17.78	17.90	0.695	0.700	0.705
e3	7.62	7.87	8.12	0.300	0.310	0.320
F	7.29	7.49	7.70	0.287	0.295	0.303
I			3.83			0.151
K	10.90		12.1	0.429		0.476
L	1.14		1.5	0.045		0.059



0056437F

## FPC-16 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A	6.75	6.91	7.06	0.266	0.272	0.278
B	9.76	9.94	10.14	0.384	0.392	0.399
C	1.49		1.95	0.059		0.077
D	0.102	0.127	0.152	0.004	0.005	0.006
E	8.76	8.89	9.01	0.345	0.350	0.355
F		1.27			0.050	
G	0.38	0.43	0.48	0.015	0.017	0.019
H	6.0			0.237		
L	18.75		22.0	0.738		0.867
M	0.33	0.38	0.43	0.013	0.015	0.017
N		4.31			0.170	



0016030E

**Table 8: Revision History**

Date	Revision	Description of Changes
10-May-2004	1	First Release

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